OSRAM LCB CRBP.01 Datasheet

Published by ams-OSRAM AG Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved





OSLON[®] Signal

LCB CRBP.01

The OSLON® Signal combines a compact form factor with high efficiency and electrically insulated thermal pad. The square package matches the optical center with the mechanical center. This provides easy clustering flexibility and high packing density for a maximum flux density.

The color bins are defined for best fit to most signaling norms.



Applications

- Dynamic Signaling

Features

- Package: SMD ceramic package with silicone lens
- Chip technology: UX:3
- Typ. Radiation: 120°
- Color: Cx = 0.16, Cy = 0.12 acc. to CIE 1931 (• converted blue)
- Corrosion Robustness Class: 3B
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)
- Bipolar, back to back (B2B) ESD: Minimum reverse voltage 5V





Ordering Information

Туре	Luminous Flux ¹⁾ I _F = 350 mA Φ _V	Ordering Code
LCB CRBP.01-KXLX-3B6B-Y474	71.0 130.0 lm	Q65113A4672



Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T _{op}	min.	-40 °C
		max.	125 °C
Storage Temperature	T _{stg}	min.	-40 °C
		max.	125 °C
Junction Temperature	Tj	max.	150 °C
Junction Temperature for short time applications	T _j	max.	175 °C
Forward current	I _F	min.	30 mA
T _s = 25 °C		max.	1000 mA
Surge current	I _{FS}	max.	2000 mA
t ≤ 10 μs; D = 0.005 ; T _s = 25 °C	15		
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV

* The median lifetime (L70/B50) for Tj = 175° C is 100h.



Characteristics

 $I_{_{\rm F}}$ = 350 mA; $T_{_{\rm S}}$ = 25 °C

Parameter	Symbol		Values
Chromaticity Coordinate ²⁾	Cx	typ.	0.16
	Су	typ.	0.12
Viewing angle at 50% I_v	2φ	typ.	125 °
Forward Voltage ³⁾	V _F	min.	2.65 V
I _F = 350 mA	•	typ.	2.90 V
		max.	3.25 V
Reverse voltage (ESD device)	V _{r esd}	min.	5 V
Reverse voltage 4)	V _R	max.	7 V
I _R = 5 mA			
Real thermal resistance junction/solderpoint ⁵⁾	$R_{thJS real}$	typ.	9.4 K / W
	(135 Teal	max.	11.2 K / W
Electrical thermal resistance junction/solderpoint ⁵⁾	$R_{thJS elec.}$	typ.	3.5 K / W
with efficiency η_e = 62.4 %	(1)5 666.	max.	4.2 K / W



Brightness Groups

Group	Luminous Flux ¹⁾ I _F = 350 mA min. Φ _v	Luminous Flux ¹⁾ I _F = 350 mA max. Φ _v	Luminous Intensity ⁶⁾ I _F = 350 mA typ. I _v	
КХ	71.0 lm	82.0 lm	22.3 cd	
KY	82.0 lm	97.0 lm	26.1 cd	
KZ	97.0 lm	112.0 lm	30.5 cd	
LX	112.0 lm	130.0 lm	35.3 cd	

Forward Voltage Groups

Group	Forward Voltage ³⁾ I _F = 350 mA min. V _F	Forward Voltage ³⁾ I _F = 350 mA max. V _F	
Y4	2.65 V	2.85 V	
34	2.85 V	3.05 V	
74	3.05 V	3.25 V	



Chromaticity Coordinate Groups



Chromaticity Coordinate Groups

Group	Сх	Су	Group	Cx	Су
3B	0.1297	0.0503	5B	0.1096	0.0868
	0.1748	0.1131		0.1743	0.1581
	0.1750	0.0985		0.1746	0.1369
	0.1355	0.0399		0.1195	0.0688
4B	0.1195	0.0688	6B	0.0969	0.1099
	0.1746	0.1369		0.1740	0.1827
	0.1748	0.1131		0.1743	0.1581
	0.1297	0.0503		0.1096	0.0868



Group Name on Label

Example: KX-3B-34		E 11/1
Brightness	Color Chromaticity	Forward Voltage
KX	3B	34



Relative Spectral Emission⁶⁾

 $\Phi_{_{rel}}$ = f (λ); I_F = 350 mA; T_S = 25 °C



Radiation Characteristics⁶⁾

 $I_{rel} = f(\phi); T_s = 25 \ ^{\circ}C$





Forward current ⁶⁾

 $I_{_{\rm F}} = f(V_{_{\rm F}}); T_{_{\rm S}} = 25 \ ^{\circ}{\rm C}$



Relative Luminous Flux ^{6), 7)}

 $\Phi_{v}/\Phi_{v}(350 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$



Chromaticity Coordinate Shift 6)

 ΔCx , $\Delta Cy = f(I_F)$; $T_S = 25 \ ^{\circ}C$





Forward Voltage ⁶⁾

 $\Delta V_{_F} = V_{_F} - V_{_F}(25 \text{ °C}) = f(T_{_J}); I_{_F} = 350 \text{ mA}$



Relative Luminous Flux⁶⁾

 $\Phi_v/\Phi_v(25 \text{ °C}) = f(T_i); I_F = 350 \text{ mA}$



Chromaticity Coordinate Shift ⁶⁾

 ΔCx , $\Delta Cy = f(T_i)$; $I_F = 350 \text{ mA}$





Max. Permissible Forward Current

 $I_F = f(T)$



Permissible Pulse Handling Capability

 $I_{_{\rm F}}$ = f(t_{_{\rm p}}); D: Duty cycle; T_{_{\rm S}} = 25 °C



Permissible Pulse Handling Capability

 $I_{_{F}} = f(t_{_{D}})$; D: Duty cycle; $T_{_{S}} = 85 \text{ °C}$





Dimensional Drawing ⁸⁾



Further Information:

Approximate Weight:	26.8 mg
Corrosion test:	Class: 3B Test condition: 40°C / 90 % RH / 15 ppm H ₂ S / 14 days (stricter than IEC 60068-2-43)
ESD advice:	The device is protected by ESD device which is connected in parallel to the Chip.



Recommended Solder Pad⁸⁾



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.



Reflow Soldering Profile





Profile Feature	Symbol	Symbol Pb-Free (SnAgCu) Assembly			Unit	
		Minimum	Recommendation	Maximum		
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s	
Time t _s T _{smin} to T _{smax}	t _s	60	100	120	S	
Ramp-up rate to peak ^{*)} $\rm T_{Smax}$ to $\rm T_{P}$			2	3	K/s	
Liquidus temperature	TL		217		°C	
Time above liquidus temperature	t		80	100	S	
Peak temperature	Τ _Ρ		245	260	°C	
Time within 5 °C of the specified peak temperature T_p - 5 K	t _P	10	20	30	S	
Ramp-down rate* T _P to 100 °C			3	6	K/s	
Time 25 °C to T _P				480	S	

All temperatures refer to the center of the package, measured on the top of the component

 * slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

LCB CRBP.01 DATASHEET



Taping⁸⁾





Tape and Reel ⁹⁾



Reel Dimensions

А	W	N _{min}	W ₁	$W_{2\text{max}}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	600



Barcode-Product-Label (BPL)



Dry Packing Process and Materials⁸⁾



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Type Designation System





Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



Glossary

- ¹⁾ **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 8 % and an expanded uncertainty of ± 11 % (acc. to GUM with a coverage factor of k = 3).
- ²⁾ **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (acc. to GUM with a coverage factor of k = 3).
- ³⁾ **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of k = 3).
- ⁴⁾ Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- ⁵⁾ **Thermal Resistance:** Rth max is based on statistic values (6σ).
- ⁶⁾ **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ⁷⁾ **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- ⁸⁾ **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ⁹⁾ **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision History

Version	Date	Change
1.0	2022-10-17	Initial Version
1.1	2023-02-01	Applications Electro - Optical Characteristics (Diagrams) Derating (Diagrams)



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

Published by ams-OSRAM AG Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved

